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PATENT NUMBER and
ISSUE DATE

APPL NUM 10079235	FILING DATE 02/19/2002	CLASS 257	SUBCLASS 327	GAU 2811	EXAMINER Hu
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**APPLICANTS: Conn Robert;
**CONTINUING DATA VERIFIED:
** FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input checked="" type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's initials	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO X-736 US
TITLE : Method to produce a factory programmable IC using standard IC wafers and the structure U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)		

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
ISSUE FEE		Primary Examiner	
Amount Due	Date Paid	Total Claims	Print Claim for O.G
<input type="checkbox"/> TERMINAL DISCLAIMER		DRAWING	
		Sheets Drwg.	Figs. Drwg.
		Print Fig.	
		Application Examiner	
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